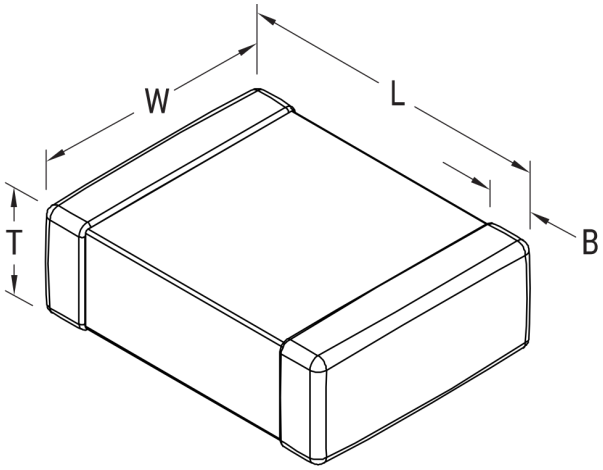
C1825C183J1GACTU

Aliases (C1825C183J1GAC7800)

SMD Comm C0G, Ceramic, 0.018 uF, 5%, 100 VDC, C0G, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1825



Click here for the 3D model.

Dimensions	
Chip Size	1825
L	4.5mm +/-0.3mm
W	6.4mm +/-0.4mm
T	1.4mm +/-0.15mm
B	0.6mm +/-0.35mm

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	1000

General Information	
Series	SMD Comm C0G
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	190 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	0.018 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	5%
Voltage DC	100 VDC
Dielectric Withstanding Voltage	250 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	C0G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	55.5556 GOhms